



BSI Standards Publication

## Test methods for electrical materials, printed board and other interconnection structures and assemblies

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Part 2-630: Test methods for materials for interconnection structures –  
Moisture absorption after pressure vessel conditioning

## National foreword

This British Standard is the UK implementation of EN IEC 61189-2-630:2018. It is identical to IEC 61189-2-630:2018.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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**Compliance with a British Standard cannot confer immunity from legal obligations.**

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### Amendments/corrigenda issued since publication

| Date | Text affected |
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English Version

Test methods for electrical materials, printed board and other  
interconnection structures and assemblies - Part 2-630: Test  
methods for materials for interconnection structures - Moisture  
absorption after pressure vessel conditioning  
(IEC 61189-2-630:2018)

Méthodes d'essai pour les matériaux électriques, les cartes  
imprimées et autres structures d'interconnexion et  
ensembles - Partie 2-630: Méthodes d'essai des matériaux  
pour structures d'interconnexion - Absorption d'humidité  
après conditionnement dans un récipient sous pression  
(IEC 61189-2-630:2018)

Prüfverfahren für Elektromaterialien, Leiterplatten und  
andere Verbindungsstrukturen und Baugruppen - Teil 2-  
630: Prüfverfahren für Materialien für  
Verbindungsstrukturen - Feuchteaufnahme nach  
Druckbehälterbeanspruchung  
(IEC 61189-2-630:2018)

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European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

## **European foreword**

The text of document 91/1471/CDV, future edition 1 of IEC 61189-2-630, prepared by IEC/TC 91 "Electronics assembly technology" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 61189-2-630:2018.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2019-04-10
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2021-07-10

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## **Endorsement notice**

The text of the International Standard IEC 61189-2-630:2018 was approved by CENELEC as a European Standard without any modification.

**Annex ZA**  
(normative)

**Normative references to international publications  
with their corresponding European publications**

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cenelec.eu](http://www.cenelec.eu).

| <u>Publication</u> | <u>Year</u> | <u>Title</u>                                                           | <u>EN/HD</u> | <u>Year</u> |
|--------------------|-------------|------------------------------------------------------------------------|--------------|-------------|
| IEC 60194          | -           | Printed board design, manufacture and-assembly - Terms and definitions |              | -           |